



### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

## **Product Summary**

Device	BV <sub>DSS</sub>	RDS(ON) Max	ID MAX TA = +25°C
Q1	20V	$25m\Omega$ @ V <sub>GS</sub> = 4.5V	6.0A
N-Channel	200	$35m\Omega$ @ V <sub>GS</sub> = 2.5V	5.1A
Q2	201/	75mΩ @ V <sub>GS</sub> = -4.5V	-3.5A
P-Channel	-20V	140mΩ @ V <sub>GS</sub> = -2.5V	-2.5A

#### **Features**

- PCB Footprint of 4mm<sup>2</sup>
- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Maximum Height
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMC2025UFDBQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

# **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

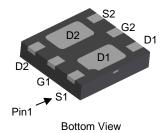
- Load Switch
- Power Management Functions
- Portable Power Adaptors

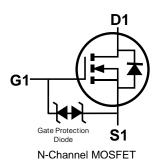
## **Mechanical Data**

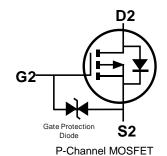
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 4
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)

#### U-DFN2020-6 (Type B)









Internal Schematic

## **Ordering Information** (Note 4)

ĺ	Part Number	Case	Packaging
	DMC2025UFDBQ-7	U-DFN2020-6 (Type B)	3,000/Tape & Reel
	DMC2025UFDBQ-13	U-DFN2020-6 (Type B)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



## **Marking Information**



O4 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 1 = 2021)

W = Week (ex: a = Week 27; z Represents Week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2
Week	Week 1-26			27-52				53				
Code	A-Z			A-Z a-z								

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	Χ	Υ	Z

## **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit
Drain-Source Voltage			V <sub>DSS</sub>	20	-20	V
Gate-Source Voltage			Vgss	±10	±8	V
Continuous Drain Current (Note 6) N-Channel: V <sub>GS</sub> = 4.5V P-Channel: V <sub>GS</sub> = -4.5V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lo	6.0 4.8	-3.5 -2.8	Α
Maximum Continuous Body Diode Forward Cur	rent (Note 6	)	Is	2	-1.0	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	20	-10	А
Avalanche Current (L = 0.1mH) (Note 7)			I <sub>AS</sub>	8	-13	А
Avalanche Energy (L = 0.1mH) (Note 7)			Eas	8	8.5	mJ

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>OJA</sub>	178	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	92	°C/W
Thermal Resistance, Junction to Case (Note 6)		Rejc	30	C/VV
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

 Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate. Notes:

7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.



# Electrical Characteristics Q1 N-CHANNEL (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	Syllibol	IVIIII	тур	IVIAX	Unit	Test Condition
Drain-Source Breakdown Voltage	BVpss	20	_	Ι _	V	V <sub>G</sub> S = 0V, I <sub>D</sub> = 250µA
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	Ipss		_	1	μA	Vps = 20V, Vgs = 0V
Gate-Source Leakage	I <sub>GSS</sub>			±10	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)	1000				P* 1	VG3 - 110 V, VD3 - 0 V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.5	_	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
			_	25	_	Vgs = 4.5V, ID = 4A
Static Drain-Source On-Resistance	RDS(ON)	_		35	mΩ	Vgs = 2.5V, ID = 4A
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.2	V	$V_{GS} = 0V$ , $I_S = 5A$
DYNAMIC CHARACTERISTICS (Note 9)					I.	
Input Capacitance	Ciss	_	486	_		V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1.0MHz
Output Capacitance	Coss	_	92	_	pF	
Reverse Transfer Capacitance	Crss	_	77	_		
Gate Resistance	Rg	_	3.2	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	5.9	_		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	12.3	_	nC	\/ 10\/ I- 0.5A
Gate-Source Charge	Qgs	_	0.8	_	iiC	$V_{DS} = 10V, I_{D} = 6.5A$
Gate-Drain Charge	Qgd	_	2.2	_		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.4	_		
Turn-On Rise Time	t <sub>R</sub>	_	5.4	_		$V_{DS} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	tD(OFF)	_	17.6	_	ns	$R_g = 6\Omega$ , $R_L = 10\Omega$ , $I_D = 1A$
Turn-Off Fall Time	tF	_	9.3	_		
Reverse Recovery Time	trr	_	7.7	_	ns	I <sub>F</sub> = 1A, di/dt = 100A/μs
Reverse Recovery Charge	Q <sub>RR</sub>		1.5	_	nC	I <sub>F</sub> = 1A, di/dt = 100A/μs

Notes:

Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.



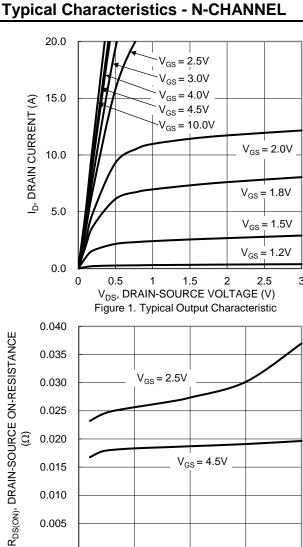
# Electrical Characteristics Q2 P-CHANNEL (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20			V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	-1.0	μΑ	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±10	μA	Vgs = ±8V, Vps = 0V
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	$V_{GS(TH)}$	-0.35	_	-1.4	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	-	_	_	75	mΩ	$V_{GS} = -4.5V, I_D = -2.9A$
Static Drain-Source On-Resistance	RDS(ON)	_	_	140	11122	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -2.3A
Diode Forward Voltage	VsD	_	_	-1.2	V	VGS = 0V, IS = -3.0A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	642	_	pF	
Output Capacitance	Coss	_	98	_	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	87	_	pF	1 = 1.0WH12
Gate Resistance	Rg	_	26.5	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	0	_	8.8	_	nC	
Total Gate Charge (V <sub>GS</sub> = -8V)	$Q_g$	_	15	_	nC	10/1 0.74
Gate-Source Charge	Qgs	_	0.9	_	nC	$V_{DS} = -10V, I_{D} = -3.7A$
Gate-Drain Charge	Q <sub>gd</sub>	_	2.9	_	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	5.5	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	22.6	_	ns	V <sub>DD</sub> = -10V, V <sub>GS</sub> = -4.5V,
Turn-Off Delay Time	tD(OFF)	_	34.1	_	ns	$R_L = 3.3\Omega$ , $R_g = 1\Omega$
Turn-Off Fall Time	t <sub>F</sub>	_	34.3	_	ns	
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	13	_	ns	I <sub>S</sub> = -3.0A, dI/dt = 100A/μs
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	3.3	-	nC	Is = -3.0A, dI/dt = 100A/µs

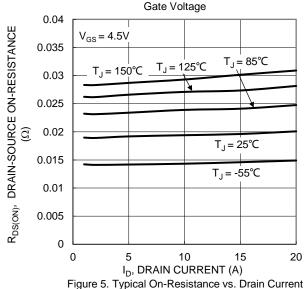
Notes: 8. Short duration pulse test used to minimize self-heating effect.

<sup>9.</sup> Guaranteed by design. Not subject to product testing.

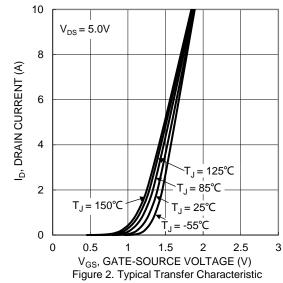


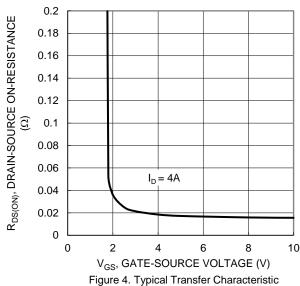


 $V_{GS} = 4.5V$ 0.015 0.010 0.005 0.000 5 10 15 20 I<sub>D</sub>, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and



and Temperature



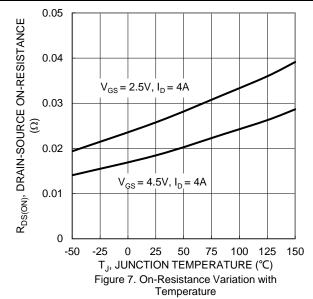


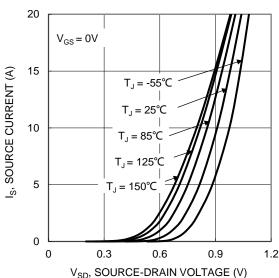
2 R<sub>DS(ON)</sub>, DRAIN-SOURCE ON-RESISTANCE 1.8  $V_{GS} = 4.5 V, I_{D} = 4A$ 1.6 1.4 (NORMALIZED) 1.2 1  $V_{GS} = 2.5V, I_{D} = 4A$ 0.8 0.6 0.4 0.2 0 -50 -25 0 25 50 75 100 125 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

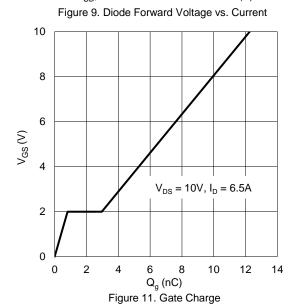
Figure 6. On-Resistance Variation with Temperature

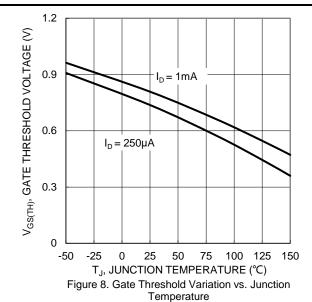


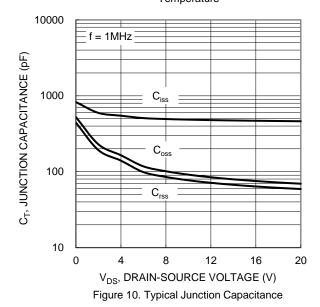
## Typical Characteristics - N-CHANNEL (continued)

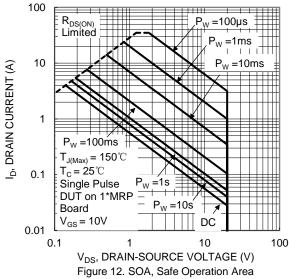






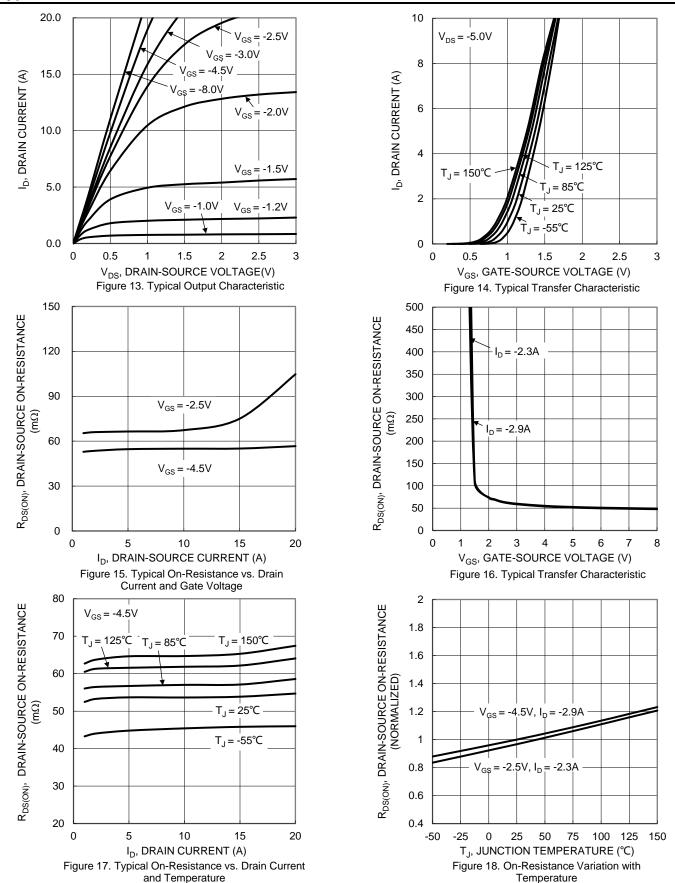






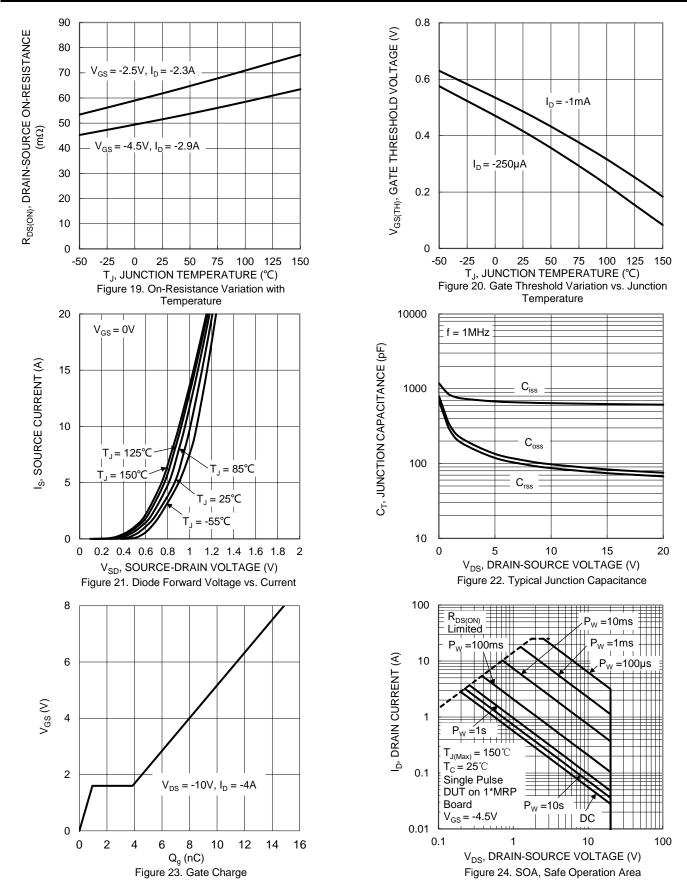


## **Typical Characteristics - P-CHANNEL**





# Typical Characteristics - P-CHANNEL (continued)





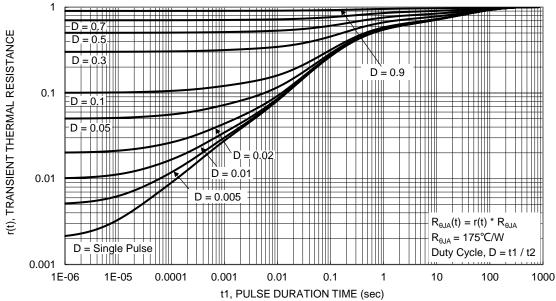


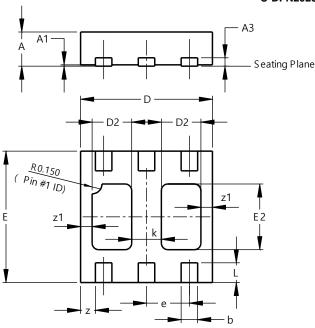
Figure 25. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## U-DFN2020-6 (Type B)

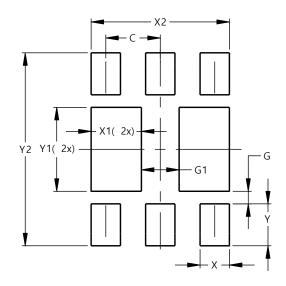


U-DFN2020-6 Type B						
Dim	Min	Max	Тур			
Α	0.545	0.605	0.575			
A1	0.00	0.05	0.02			
A3	-	-	0.13			
b	0.20	0.30	0.25			
D	1.95	2.075	2.00			
D2	0.50	0.70	0.60			
е	-	-	0.65			
Е	1.95	2.075	2.00			
E2	0.90	1.10	1.00			
k	-	-	0.45			
L	0.25	0.35	0.30			
Z	-	-	0.225			
z1	-	-	0.175			
All	Dimens	ions in	mm			

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Y	0.500
Y1	1.000
Y2	2.300



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